

# **DATA SHEET**

**HIGH FREQUENCY** 

SMD type antennas for BT/802.11b/g application 2.45 GHz size 5.3 × 2.0



**Phicomp** 





### **High Frequency**

## SMD type antennas for BT/802.11b/g application 2.45 GHz size $5.3 \times 2.0$

#### **FEATURES**

- Designed for 2.45 GHz ISM-band
- · Simplifies antenna circuitry
- NiSn lead-free terminations
- · Suitable for wave and reflow soldering
- · Supplied in tape on reel.

#### **APPLICATIONS**

- Telecommunications
- Computing (PCs, printers, PDAs)
- Wireless office data communications including WLAN
- Consumer electronics (wireless headphones).

#### **DESCRIPTION**

This 2.45 GHz ceramic multilayer antenna has been designed to meet the requirements of the Bluetooth  $^{TM(1)}$  and IEEE 802.11b/g wireless communications protocol. It consists of a rectangular block of low-dielectric ceramic material and is fabricated in a water-based non-toxic process. The antenna is capable of providing good connectivity using near 50  $\Omega$  microstrip directly onto the PC board.

#### **Notes**

 Bluetooth is a trademark owned by Telefonieaktiebolaget L M Ericsson, Sweden.

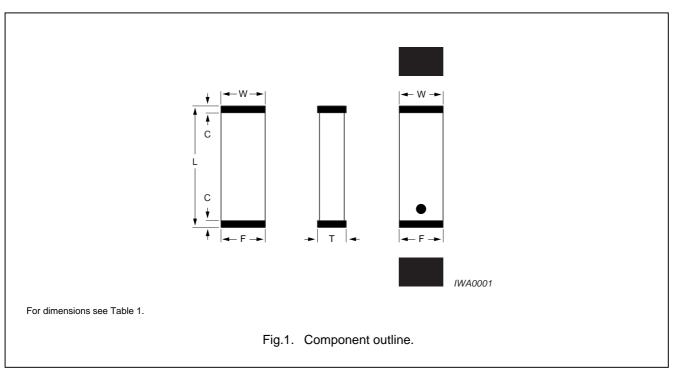
#### **QUICK REFERENCE DATA**

DESCRIPTION	VALUE
Centre frequency	2.45 GHz
	0 type/01type/02 type/03 type/Default/04 type/05 type
Bandwidth	>100 MHz
Gain	4 dBi max. (depends on the special environment)
VSWR	2.5 max. (depends on the special environment)
Polarization	Linear
Azimuth beam width	Omni-directional
Impedance	50 Ω
Power dissipation	1 W
Operating temperature	−55 to +85 °C
Terminations	NiSn
Resistance to soldering heat	260 °C for 10 seconds

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#### **MECHANICAL DATA**



#### **Physical dimensions**

Table 1 Antenna dimensions

SYMBOL	DETAILS	DIMENSIONS (mm)
	22171120	· · · ·
L	_	5.3 ±0.20
W	_	2.0 ±0.20
Т	_	1.3 ±0.20
F	feed termination	2.0 ±0.20
С	_	0.4 ±0.25

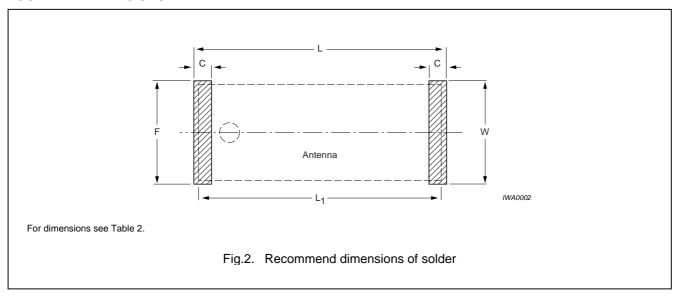
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#### **ELECTRICAL CHARACTERISTICS**

DESCRIPTION	VALUE
Centre frequency	2.45 GHz
	0 type/01type/02 type/03 type/Default/04 type/05 type
Bandwidth	>100 MHz
Gain	4 dBi max. (depends on the special environment)
VSWR	2.5 max. (depends on the special environment)
Polarization	Linear
Azimuth beam width	Omni-directional
Impedance	50 Ω
Power dissipation	1 W
Operating temperature	−55 to +85 °C
Terminations	NiSn
Resistance to soldering heat	260 °C for 10 s
Weight	0.05 g/piece

#### **FOOTPRINT DIMENSIONS**



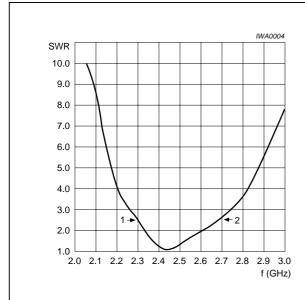
#### **Physical dimensions**

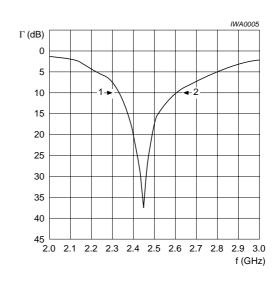
Table 2 The dimensions of antenna appearance

SYMBOL	DETAILS	DIMENSIONS (mm)
L	_	5.5 ±0.2
W	_	2.2 ±0.2
F	feed pad	2.2 ±0.2
С	_	0.5 ±0.25
L1	_	4.3 ±0.5

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Marker data:

1: SWR= 2.5; f= 2.30 GHz

2: SWR= 2.5; f= 2.70 GHz

Marker data:

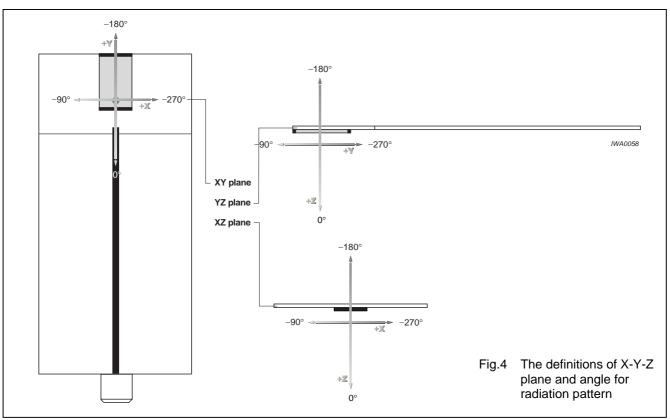
1:  $\Gamma$ = -10 dB; f= 2.33 GHz 2:  $\Gamma$ = -10 dB; f= 2.60 GHz

Pre-tuning reference only, after-tuning performance is depending on customer installation.

 $\label{eq:Fig.3} \textbf{ The measurements of typical SWR and return loss on the special environment } .$ 

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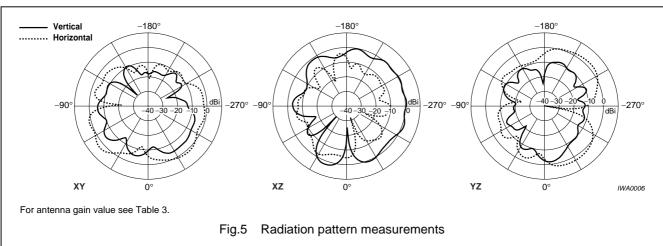


 Table 3
 Max. and avg. antenna gain value of radiation pattern

Plane	XY (dBi)	XZ(dBi)	YZ (dBi)
Vertical Pol. (max.)	-3.8	2.6	-1.8
Vertical Pol. (avg.)	-8.4	-1.6	-9.7
Horizontal Pol. (max.)	4.0	-1.9	2.7
Horizontal Pol. (avg.)	-2.2	-8.4	-2.1
Total gain (max.)	4.0	2.7	2.7
Total gain (avg.)	-1.9	-1.3	-1.9

### **High Frequency**

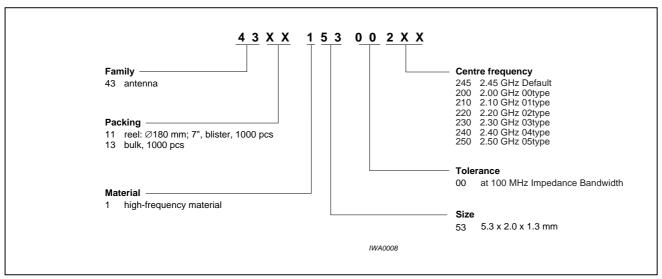
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#### **ORDERING INFORMATION**

Components may be ordered by using either a Phycomp's unique 12NC or the simple 17-digit clear text code (Yageo part number)

#### 12NC ORDERING CODE

EXAMPLE: 4311 153 00245



#### Yageo part number

EXAMPLE: CAN4311153002451K

DESCRIPTION	CODE
Family	CAN43 = antenna products
Packing	11 = 180 mm/7" blister
Materials	1 = high frequency materials
Size	$53 = 5.3 \times 2.0 \times 1.3 \text{ mm}$
Tolerance	00 = large than 100 MHz
Working Frequency <sup>(1)</sup>	245 = 2.45 GHz (Default)
	200 = 2.0 GHz (00 type)
	210 = 2.1 GHz (01 type)
	220 = 2.2 GHz (02 type)
	230 = 2.3 GHz (03 type)
	240 = 2.4 GHz (04 type)
	250 = 2.5 GHz (05 type)
Packing type	1K = 1,000 pcs per reel

#### **Notes**

1. Depends on the special environment.

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#### **TESTS AND REQUIREMENTS**

Table 4 Test procedures and requirements

IEC 384-10/ CECC32 100 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.4		mounting	the antenna may be mounted on printed-circuit boards or ceramic substrates by applying wave soldering, reflow soldering (including vapour phase soldering) or conductive adhesive	no visible damage
4.5		visual inspection and dimension check	any applicable method using × 10 magnification	in accordance with specification (chip off 4 mm)
4.8		adhesion	a force of 3 N applied for 10 s to the line joining the terminations and in a plane parallel to the substrate	
4.9		bond strength of plating on end face	mounted in accordance with CECC 32 100, paragraph 4.4	no visible damage
			conditions: bending 0.5 mm at a rate of 1 mm/s; radius jig: 340 mm; 2 mm warp on FR4 board of 90 mm length	no visible damage
4.10	20 (Tb)	resistance to soldering heat	260 ±5 °C for 10 ±5 s in a static solder bath	the terminations should be well tinned after recovery; central frequency changed to ±6%
		resistance to leaching	at 260 $\pm$ 5 °C for 30 $\pm$ 1 s in a static solder bath	using visual enlargement of × 10, dissolution of the terminations should not exceed 10%
4.11	20 (Ta)	solderability	zero hour test, and test after storage (20 to 24 months) in original atmosphere; unmounted chips completely immersed for 2 ±0.5 s at 235 ±5 °C	good tinning (≥ 75% covered) at terminations

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IEC 60384-10/ CECC32 100 CLAUSE	IEC 60384-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.12	4 (Na)	rapid change of temperature	−55 °C (30 minutes) to +85 °C (30 minutes); 100 cycles	no visual damage; central frequency changed to $\pm 6\%$
4.14	3 (Ca)	damp heat	500 ±12 hours at 60 °C; 90 to 95% RH	no visual damage; 2 hours recovery; central frequency changed to ±6%
4.15		endurance	500 ±12 hours at 85 °C	no visual damage; 2 hours recovery; central frequency changed to ±6%

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#### **PACKING**

#### Tape and reel specifications

Tape and reel specifications are in accordance with "IEC 60286-3". Basic dimensions are given in Fig. 6 and 7, and Table 5 and 6.

#### Peel-off force

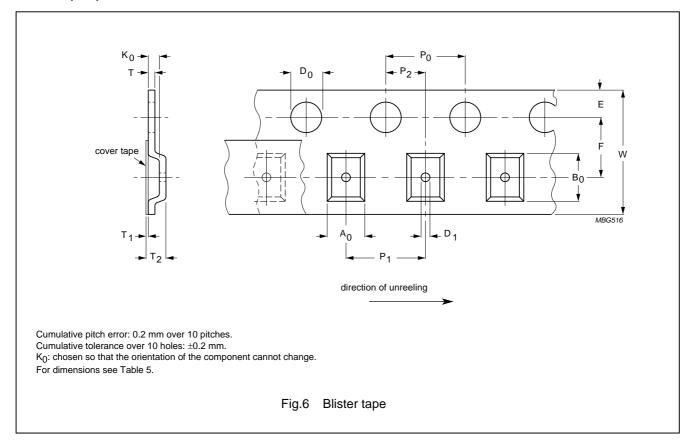
Peel-off force of the blister tape is in accordance with "IEC 60286-3", that is, at a peel-off speed of 300  $\pm$ 10 mm/minute, 0.1 N to 1.3 N for 16 mm tape. The peel-off angle should be between 165° and 180°

#### Blister tape

#### **ENVIRONMENTAL CONSIDERATIONS**

- Cover tape, carrier tape and reel do not contain environmentally harmful PVC materials.
- Because the carrier tape is made of polycarbonate, a homogeneous material (mono-plastic), it is ideally suited for recycling.
- Compared to other PVC-free materials polycarbonate shows excellent stiffness and very little deformation with temperature.

#### Blister tape specifications



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Table 5 Dimensions of blister tape; see Fig. 6

SYMBOL	DIMENSION	TOLERANCE	UNIT
A <sub>0</sub> nominal clearance; note 1	2.28	±0.10	mm
B <sub>0</sub> nominal clearance; note 1	5.70	±0.10	mm
K <sub>0</sub> nominal clearance; note 1	1.58	±0.10	mm
W	12.0	±0.30	mm
Е	1.75	±0.10	mm
F	5.50 ±0.05		mm
$D_0$	1.50	±0.10	mm
$D_1$	1.50 ±0.25		mm
P <sub>0</sub>	4.0 ±0.10		mm
P <sub>1</sub>	4.0 ±0.10		mm
P <sub>2</sub>	2.0 ±0.05 m		mm
Т	0.229	0.229 ±0.02 mm	

#### Note

- 1. Possible product displacement in pocket.
- 2.  $P_0$  pitch tolerance over any 10 pitches is  $\pm 0.2$  mm.

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#### **Reel specifications**

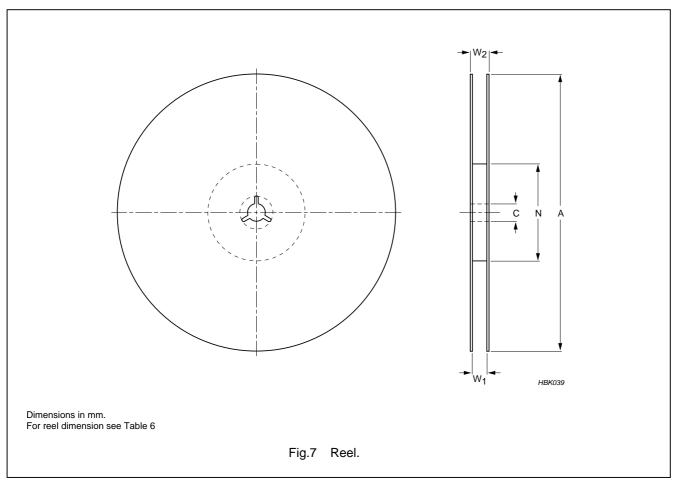


Table 6 Reel dimensions; see Fig.7

TAPE WIDTH (mm)	A (mm)	C (mm)	N (mm)	W₁ (mm)	W <sub>2</sub> (mm)	QUANTITY PER REEL (pcs)
12 ±0.3	180 ±1.0	19 ±2.0	58 ±2.0	12.4 ±2.0	18.4 ±2.0	1,000

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#### **REVISION HISTORY**

Revision	Date	Change Notification	Description
Rev.3	2004 July 15	-	- Updated company logo
Rev.4	2004 Oct 12	- Add more types of central frequency products for customized layout. Eliminate standard demo board.	